

**N-Ch MOSFET** 

### **General Description**

The WST3416E uses advanced trench technology to provi de excellent  $R_{\text{DS}(\text{ON})}$ , low gate charge

and operation with gate voltages as low as 1.1V. This device is suitable for use as a load switch or in PWM applications. It is ESD protected.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

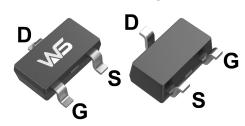
### **Product Summery**

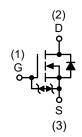
BV <sub>DSS</sub>	R <sub>DSON</sub>	I <sub>D</sub>
20V	14mΩ	6.5A

## **Applications**

- High Frequency Point-of-Load Synchronous
  Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

## **SOT-23-3L Pin Configuration**





### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	20	V
$V_{GS}$	Gate-Source Voltage	±8	V
I <sub>D</sub> @T <sub>c</sub> =25℃	I <sub>D</sub> @T <sub>c</sub> =25℃ Continuous Drain Current, V <sub>GS</sub> @ 4.5V <sup>1</sup>		Α
I <sub>D</sub> @T <sub>c</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ 4.5V <sup>1</sup>	5.2	А
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	30	Α
P <sub>D</sub> @T <sub>A</sub> =25°C	P <sub>D</sub> @T <sub>A</sub> =25°C Total Power Dissipation <sup>3</sup>		W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	$^{\circ}$
TJ	T <sub>J</sub> Operating Junction Temperature Range		$^{\circ}$

# **Thermal Data**

Symbol	Parameter		Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-ambient <sup>1</sup>		125	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case <sup>1</sup>		80	°C/W



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	Drain-Source Breakdown Voltage V <sub>GS</sub> =0V , I <sub>D</sub> =250uA				V	
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient Reference to 25℃, I <sub>D</sub> =1mA			0.018		V/℃	
D	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =6.5A		14	22	mΩ	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =2.5V , I <sub>D</sub> =5.5A		18	25		
$V_{GS(th)}$	Gate Threshold Voltage	-V <sub>GS</sub> =V <sub>DS</sub> . In =250uA	0.4	0.7	1.1	V	
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS, ID -250UA		-3.1		mV/℃	
	Drain Source Leakage Current	V <sub>DS</sub> =16V , V <sub>GS</sub> =0V , T <sub>J</sub> =25℃			1		
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =16V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	– uA	
I <sub>GSS</sub>	Gate-Source Leakage Current V <sub>GS</sub> =±12V , V <sub>DS</sub> =0V				±10	uA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =6.5A		50		S	
R <sub>g</sub>	Gate Resistance V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz			1.8	3	Ω	
$Q_g$	Total Gate Charge (4.5V)			10	15.0		
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS}$ =15V , $V_{GS}$ =4.5V , $I_{D}$ =6.5A		4.2	8.9	nC	
$Q_gd$	Gate-Drain Charge			2.6	5.2		
T <sub>d(on)</sub>	Turn-On Delay Time			280			
Tr	Rise Time	$V_{DS}$ =10V , $V_{GS}$ =4.5V , $R_{G}$ =3 $\Omega$		328		ns	
T <sub>d(off)</sub>	Turn-Off Delay Time	RL=1.54Ω		2.24		us	
T <sub>f</sub>	Fall Time	]		3.76			
C <sub>iss</sub>	Input Capacitance			1295			
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =10V , V <sub>GS</sub> =0V , f=1MHz		160		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			87			

### **Diode Characteristics**

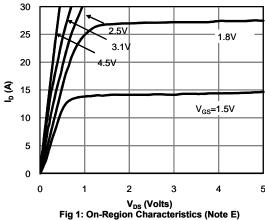
Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,4</sup>	V =V =0V Force Current			2.0	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			10	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1.1	V
t <sub>rr</sub>	Reverse Recovery Time	IE-6 EA dI/dt-100A/up T -25°C		31	41	nS
Qrr	Reverse Recovery Charge	IF=6.5A,dI/dt=100A/μs , T <sub>J</sub> =25℃		6.8		nC

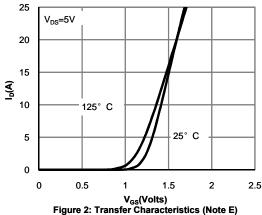
#### Note

- 1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<=10sec.
- 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3.The power dissipation is limited by 150 ℃ junction temperature
- 4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**





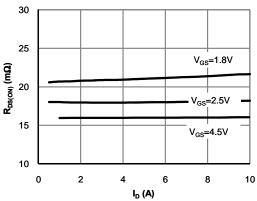


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

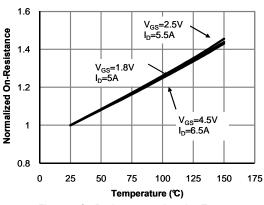


Figure 4: On-Resistance vs. Junction Temperature (Note E)

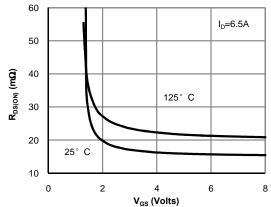
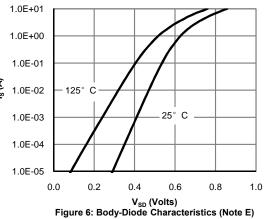
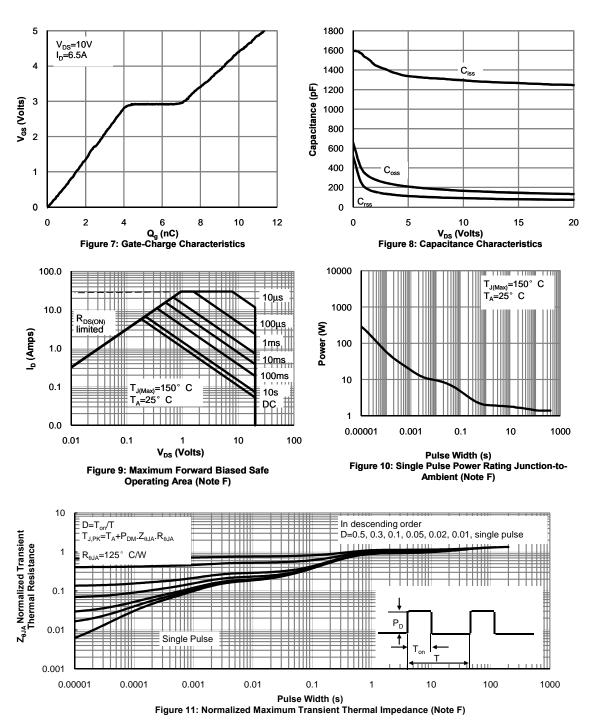


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)



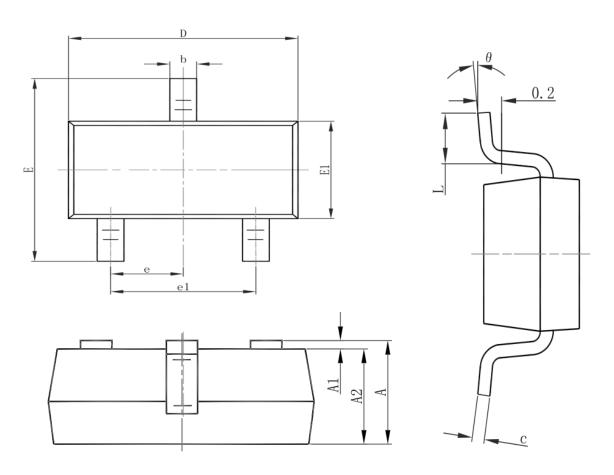


### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





# **Packaging information**



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E1	1.500	1.700	0.059	0.067	
E	2.650	2.950	0.104	0.116	
е	0.950(BSC)		0.037(BSC)		
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	



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